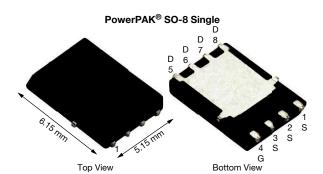
www.vishay.com

Vishay Siliconix

N-Channel 100 V (D-S) MOSFET



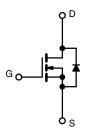
PRODUCT SUMMARY					
V _{DS} (V)	100				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0080				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 7.5 \text{ V}$	0.0090				
Q _g typ. (nC)	26.5				
I _D (A)	65.8				
Configuration	Single				

FEATURES

- TrenchFET® Gen IV power MOSFET
- Very low R_{DS} x Q_g figure-of-merit (FOM)
- Tuned for the lowest R_{DS} x Q_{oss} FOM
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

APPLICATIONS

- Synchronous rectification
- · Primary side switch
- DC/DC converters
- Power supplies
- Motor drive control



HALOGEN

FREE

N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiR106ADP-T1-RE3

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, u	nless otherv	wise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	100	V
Gate-source voltage		V_{GS}	± 20	V
	T _C = 25 °C		65.8	
Continuous drain current (T _{.I} = 150 °C)	T _C = 70 °C	Ι,	52.6	
Continuous drain current (1) = 150 °C)	T _A = 25 °C	I _D	16.1 ^{b, c}	
	T _A = 70 °C	1	12.9 ^{b, c}	Α
Pulsed drain current (t = 100 μs)		I _{DM}	150	^
Continuous source-drain diode current	T _C = 25 °C		75.7	
Continuous source-drain diode current	T _A = 25 °C	l _S	4.5 b, c	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	30	
Single pulse avalanche energy L = 0.1		E _{AS}	45	mJ
	T _C = 25 °C		83.3	
Maximum power dissipation	T _C = 70 °C	Ь	53.3	w
waxiinum power dissipation	T _A = 25 °C	P _D	5 b, c	VV
	T _A = 70 °C		3.2 b, c	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) ^c			260	

THERMAL RESISTANCE RATING	àS .				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.2	1.5	C/VV

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 65 °C/W
- g. $T_C = 25$ °C

Vishay Siliconix

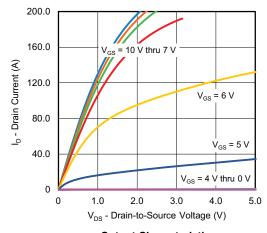
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 1 mA	-	63	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-7.3	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	-	4	V
Gate-source leakage	I _{GSS}		-	-	100	nA
-		V _{DS} = 100 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}		-	-	15	μA
On-state drain current ^a	I _{D(on)}		40	-		Α
Drain-source on-state resistance ^a	_ ` ´		-	0.0066	0.0080	Ω
	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, I_D = 10 \text{ A}$	-	0.0074	0.0090	
Forward transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A	-	72	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	2440	-	
Output capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	255	-	рF
Reverse transfer capacitance	C _{rss}		-	16.2	-	1
Tatal asta alcana		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	-	34.5	52	
Total gate charge	Q_{g}		-	26.5	40	1
Gate-source charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 15 \text{ A}$	-	12	-	nC
Gate-drain charge	Q_{gd}		-	5.3	-	
Output charge	Q _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$	-	46	-	1
Gate resistance	R_g	f = 1 MHz	0.3	0.8	1.4	Ω
Turn-on delay time	t _{d(on)}		-	15	30	
Rise time	t _r	$V_{DD} = 50 \text{ V}, R_1 = 3.33 \Omega, I_D \cong 15 \text{ A},$	-	7	14	1
Turn-off delay time	t _{d(off)}	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		25	50	1
Fall time			-	6	12	1
Turn-on delay time	t _{d(on)}		-	18	36	ns
Rise time	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_L = 3.33 \Omega, \text{ I}_D \cong 15 \text{ A},$	-	8	16	
Turn-off delay time	t _{d(off)}	V_{GEN} = 7.5 V, R_g = 1 Ω	-	22	44	
Fall time	t _f		-	7	14	
Drain-Source Body Diode Characteristi	cs		•			
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	65.8	
Pulse diode forward current	I _{SM}		-	-	150	A
Body diode voltage	V _{SD}	I _S = 5 A, V _{GS} = 0 V	-	0.75	1.1	V
Body diode reverse recovery time	t _{rr}		-	42	84	ns
Body diode reverse recovery charge	Q _{rr}	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	55	110	nC
Reverse recovery fall time	ta	$T_J = 25 ^{\circ}\text{C}$	-	26	-	
Reverse recovery rise time	t _b		-	16	-	ns

Notes

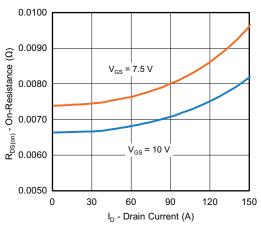
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

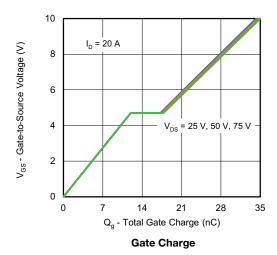


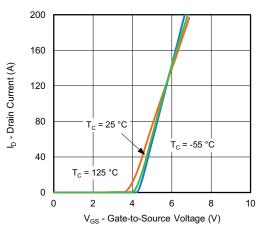


Output Characteristics

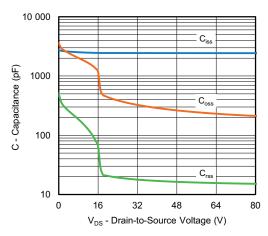


On-Resistance vs. Drain Current and Gate Voltage

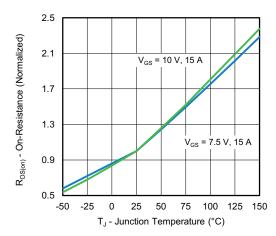




Transfer Characteristics

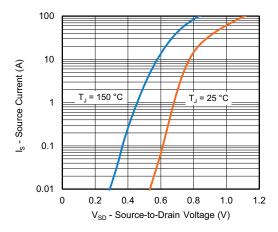


Capacitance

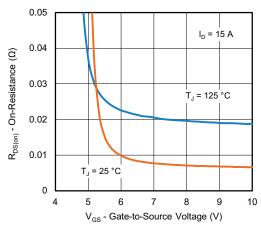


On-Resistance vs. Junction Temperature

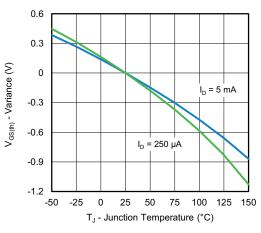




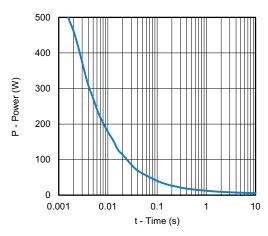
Source-Drain Diode Forward Voltage



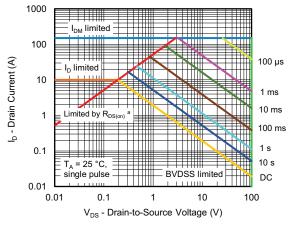
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

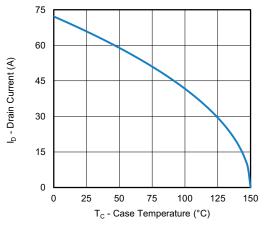


Safe Operating Area, Junction-to-Ambient

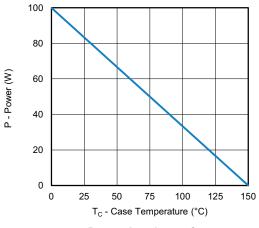
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

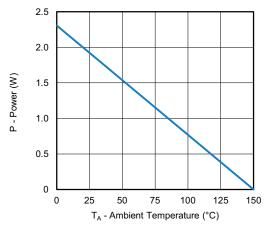




Current Derating a



Power, Junction-to-Case

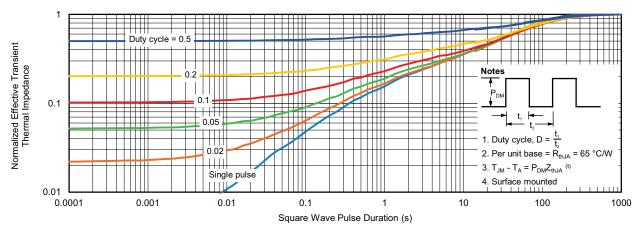


Power, Junction-to-Ambient

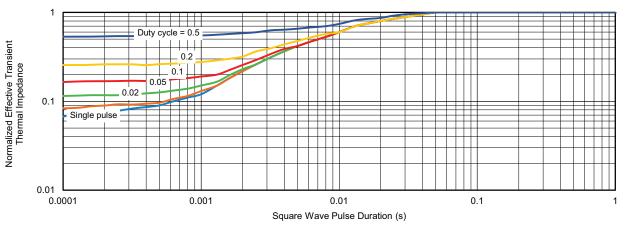
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

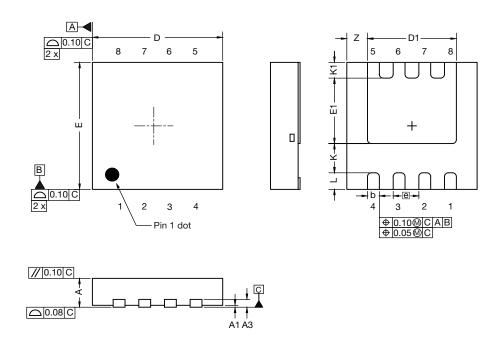


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77225.



Case Outline for PowerPAK® 1212-SWLH



DIM.		MILLIMETERS			INCHES		
DINI.	MIN.	NOM.	MAX.	MIN.	MIN. NOM.	MAX.	
Α	0.82	0.90	0.98	0.032	0.035	0.038	
A1	0.00	-	0.05	0.000	-	0.002	
A3		0.20 ref.			0.008 ref.		
b	0.25	0.30	0.35	0.010	0.012	0.014	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.15	2.25	2.35	0.085	0.089	0.093	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.60	1.70	1.80	0.063	0.067	0.071	
е		0.65 bsc.			0.026 bsc.		
K		0.76 ref.			0.030 ref.		
K1	0.41 ref.		0.41 ref. 0.016 ref.				
L	0.33	0.43	0.53	0.013	0.017	0.021	
Z	0.525 ref.			0.021 ref.			

ECN: C20-0863-Rev. B, 20-Jul-2020

DWG: 6062



RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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